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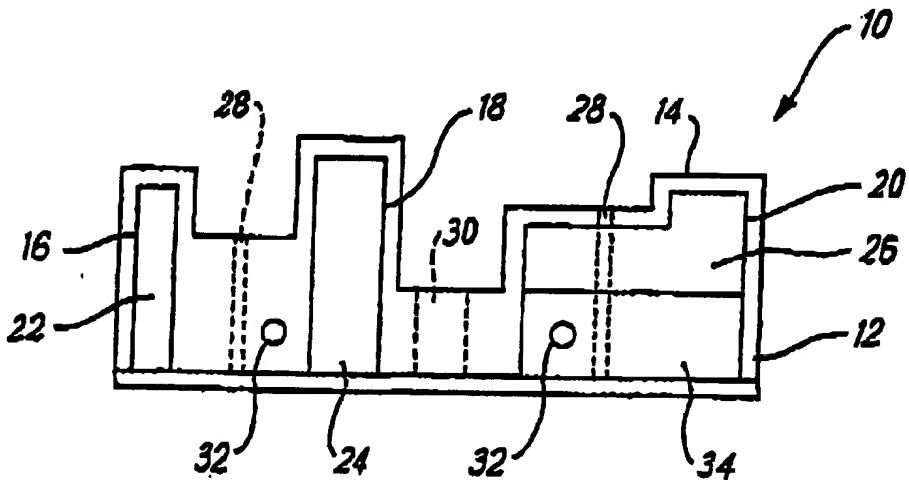
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(71) Applicant (for all designated States except US): BRITISH CERAMIC RESEARCH LIMITED [GB/GB]; Queens Road, Penkhull, Stoke-on-Trent, Staffordshire ST4 7LQ (GB).			
(72) Inventors; and			
(75) Inventors/Applicants (for US only): YIASEMIDES, George, Paul [CY/GB]; British Ceramic Research Limited, Queens Road, Penkhull, Stoke-on-Trent, Staffordshire ST4 7LQ (GB). MASELKOWSKI, Cezar, Robert [GB/GB]; British Ceramic Research Limited, Queens Road, Penkhull, Stoke-on-Trent, Staffordshire ST4 7LQ (GB).			
(74) Agent: SALES, Robert, Reginald; Swindell & Pearson, 48 Friar Gate, Derby DE1 1GY (GB).			

(54) Title: MOULDS AND METHOD OF MAKING THE SAME



(57) Abstract

This invention relates to moulds and methods for making such moulds. The moulds (10, 40, 44, 46, 48, 52, 58) comprise a first part (12) defining a mould surface formed from steel and the second part (22, 24, 26, 54) formed from a material such as copper alloy which has higher thermal conductivity than the first part (12), and the third part of nickel in the form of a thin layer or coating between the first (12) and second parts (22, 24, 26, 54). The nickel coating enables metallic bonds to be formed with the first (12) and second (22, 24, 26, 54) parts.